

Features

- Extremely high speed performance
- Blocks high voltages and currents
- Two TBU® protectors in one small package
- Simple, superior circuit protection
- Minimal PCB area
- RoHS compliant*, UL Recognized **¬N**®

Bourns® Model P500-G Series
TBU® HSPs are not recommended for POTS
applications. This series is suited for
applications requiring a dual bidirectional device
where 50 ohms of series resistance is acceptable.
For new SLIC applications, we recommend that
customers evaluate our TBU-PL Series.

The Model P500-G Series is obsolete and not recommended for new designs. The Model TBU-PL Series is the recommended alternative for VolP applications; Model P850-G Series for other applications.

P500-G Series Dual TBU® High-Speed Protectors

Transient Blocking Units - TBU® Devices

Bourns® Model P500-G TBU® products are dual high-speed bidirectional protection components, constructed using MOSFET semiconductor technology, designed to protect against faults caused by short circuits, AC power cross, induction and lightning surges.

The TBU® high speed protector, triggering as a function of the MOSFET, blocks surges and provides an effective barrier behind which sensitive electronics are not exposed to large voltages or currents during surge events. The TBU® device is provided in a surface mount DFN package and meets industry standard requirements such as RoHS and Pb Free solder reflow profiles.

Agency Approval

UL recognized component File # E315805.

Industry Standards

	Model		
Tolografia	CD 1000	Port Type 2, 4	P500-G
Telcordia	GR-1089	Port Type 3, 5	P850-G
ITU-T	K.20, K.20E,	K.21, K.21E, K.45	P850-G

Absolute Maximum Ratings (Tamb = 25 °C)

Symbol	Parameter			Value	Unit
V _{imp}	Maximum protection voltage for impulse faults with rise time \geq 1 μ se	:C	P500-Gxxx-WH	500	V
V _{rms}	Maximum protection voltage for continuous V _{rms} faults		P500-Gxxx-WH	300	V
T _{op}	Operating temperature range			-40 to +85	°C
T _{stg}	Storage temperature range			-65 to +150	°C

Electrical Characteristics (Tamb = 25 °C)

Symbol	Parameter		Min.	Тур.	Max.	Unit
l _{op}	Maximum current through the device that will not cause current blocking					
I _{trigger}	Typical current for the device to go from normal operating state to protected state	P500-G120-WH P500-G200-WH		150 275		mA
l _{out}	Maximum current through the device	Maximum current through the device P500-G120-WH P500-G200-WH				mA
R _{device}	Series resistance of the TBU® device		50	55	Ω	
R _{bal}	Line-to line series resistance difference between two TBU® d			2	Ω	
t _{block}	Maximum time for the device to go from normal operating state to protected state			1	μs	
Iquiescent	Current through the triggered TBU® device with 50 Vdc circui voltage		0.7		mA	
V _{reset}	Voltage below which the triggered TBU® device will transition normal operating state	ı to		22		V

The P-G series TBU® devices are bidirectional; specifications are valid in both directions.

*RoHS Directive 2002/95/EC Jan. 27, 2003 including annex and RoHS Recast 2011/65/EU June 8, 2011.

Specifications are subject to change without notice.

The device characteristics and parameters in this data sheet can and do vary in different applications and actual device performance may vary over time. Users should verify actual device performance in their specific applications.

Applications

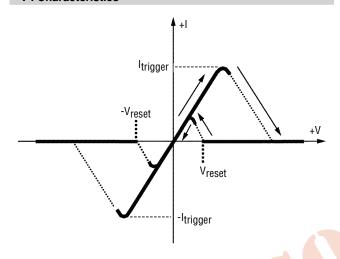
- Sensor protection
- Signal line protection

P500-G Series Dual TBU® High-Speed Protectors

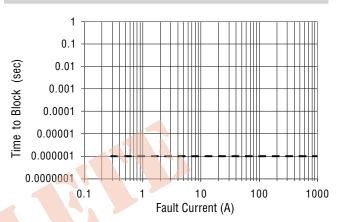
BOURNS®

Typical Performance Characteristics

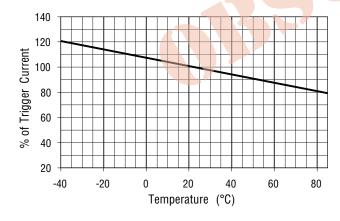
V-I Characteristics



Time to Block vs. Fault Current



Trigger Current Temperature

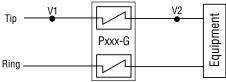


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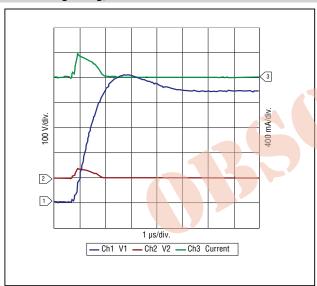
Operational Characteristics

The graphs below demonstrate the operational characteristics of the TBU® device. For each graph the fault voltage, protected side voltage, and current is presented.

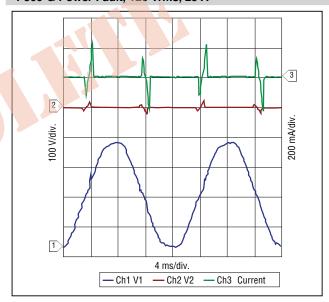
TEST CONFIGURATION DIAGRAM



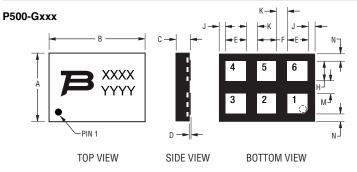
P500-G Lightning, 500 V



P500-G Power Fault, 120 Vrms, 25 A



Product Dimensions



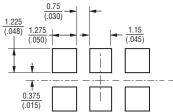
Pads 1A and 1 are internally connected; the same for pads 3A with 3, 4A with 4, and 6A with 6 This allows for one PCB layout to accommodate the P500.

Dim.		P500-G	
Dilli.	Min.	Тур.	Max.
Α	3.40	4.00	4.10
	(.139)	(.157)	(.161)
В	5.90	6.00	6.10
	(.232)	(.236)	(.240)
С	0.80	0.85	0.90
	(.031)	(.033)	(.035)
D	0.000	0.025	0.050
	(.000)	(.001)	(.002)
Ε	1.15	1.25	1.35
	(.045)	(.049)	(.053)
F	1.05	1.15	1.25
77	(.041)	(.045)	(.049)
G			
Н	1.10	1.20	1.30
	(.043)	(.047)	(.051)
J	0.375	0.425	0.475
J	(.015)	(.017)	(.019)
ĸ	0.70	0.75	0.80
	(.028)	(.030)	(.031)
L			
М	0.70	0.75	0.80
IVI	(.028)	(.030)	(.031)
N	0.375	0.425	0.475
IN	(.015)	(.017)	(.018)

DIMENSIONS: (INCHES)

Recommended Pad Layout

P500-Gxxx



Pad Designation

Pad #	Apply
1	Tip In
2	NC
3	Tip Out
4	Ring Out
5	NC
6	Rina In

NC = Solder to PCB; do not make electrical connection, do not connect to ground.

Pad Designation

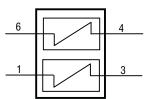
Pad #	Apply	Pad #	Apply
1A	Tip In	4A	Ring Out
1	Tip In	4	Ring Out
2	NC	5	NC
3	Tip Out	6	Ring In
3A	Tip Out	6A	Rina In

NC = Solder to PCB; do not make electrical connection, do not connect to ground.

TBU® devices have matte-tin termination finish. Suggested layout should use non-solder mask define (NSMD). Recommended stencil thickness is 0.10-0.12 mm (.004-.005 in.) with stencil opening size 0.025 mm (.0010 in.) less than the device pad size. As when heat sinking any power device, it is recommended that, wherever possible, extra PCB copper area is allowed. For minimum parasitic capacitance, do not allow any signal, ground or power signals beneath any of the pads of the device.

Block Diagram

P500-Gxxx



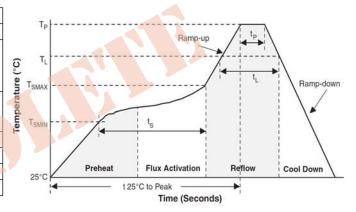
MM

Thermal Resistances

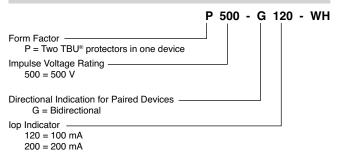
Part #	Symbol	Parameter	Value	Unit
P500-G	Du (°)	Junction to leads (package)	113	°C/W
F500-G	R _{th(j-a)}	Junction to leads (per TBU® device)	236	°C/W

Reflow Profile

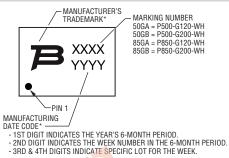
Profile Feature	Pb-Free Assembly
Average Ramp-Up Rate (Tsmax to Tp)	3 °C/sec. max.
Preheat - Temperature Min. (Tsmin) - Temperature Max. (Tsmax) - Time (tsmin to tsmax)	150 °C 200 °C 60-180 sec.
Time maintained above: - Temperature (TL) - Time (tL)	217 °C 60-150 sec.
Peak/Classification Temperature (Tp)	260 °C
Time within 5 °C of Actual Peak Temp. (tp)	20-40 sec.
Ramp-Down Rate	6 °C/sec. max.
Time 25 °C to Peak Temperature	8 min. max.







Typical Part Marking

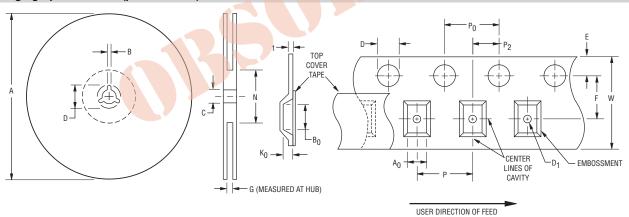


6-MONTH PERIOD CODES: A = JAN-JUN 2009 C = JAN-JUN 2010 B = JUL-DEC 2009 D = JUL-DEC 2010 E = JAN-JUN 2011 F = JUL-DEC 2011

XAMPLE: ARBC -19T DIGIT 'A' = JAN-JUN 2009 -2ND DIGIT 'R' = WEEK 18; WEEK OF APRIL 27 -3RD & 4TH DIGITS 'BC' = LOT SPECIFIC INFORMATION

TRANSITION FROM FULTEC TRADEMARK AND LOT CODE TO BOURNS TRADEMARK AND DATE CODE IN 2009.

Packaging Specifications (per EIA468-B)



QUANTITY: 3000 PIECES PER REEL

Device	A		ВС		С		D		N	
Device	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Ref.	Ref.
P500-G	326 (12.835)	330.25 (13.002)	1.5 (.059)	2.5 (.098)	12.8 (.504)	13.5 (.531)	20.2 (.795)	-	16.5 (.650)	102 (4.016)

Device	A	0	E	30)	D	1	E		F	
Device	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	max.
P500-G	4.2 (.165)	4.4 (.173)	6.2 (.244)	$\frac{6.4}{(.252)}$	1.5 (.059)	1.6 (.063)	1.5 (.059)	-	1.65 (.065)	1.85 (.073)	<u>5.4</u> (.213)	5.6 (.220)
Dovice	K	(0	Ì	P	P	0	P	2	t	,	V	V
Device	Min.	Max.	Min.	P Max.	Min.	Max.	Min.	2 Max.	Min.	Max.	Min.	Max.
Device P500-G			Min. 7.9 (.311)	Max. 8.1 (.319)				7	Min. 0.25	Max. 0.35	_	

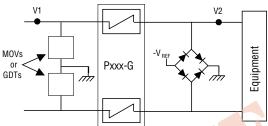
DIMENSIONS: (INCHES)

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Reference Designs

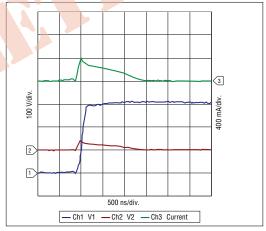
A cost-effective protection solution combines the Bourns® TBU® protection device with a pair of MOVs or Bourns® GDTs and a diode bridge. The diagram below illustrates a common configuration of these components. The graphs to the right demonstrate the operational characteristics of the circuit.

For new SLIC applications, we recommend that customers evaluate our new TBU-PL series.



Common Configuration Diagram

P500-G Configuration (GR-1089 Intra-building and 5 kV Lightning)								
Product	Qty.	Part Number	Source					
TBU® Device	1	P500-Gxxx-WH	Bourns, Inc.					
MOV	2	MOV-10D201K	Bourns, Inc.					
Diode bridge	2	GSD2004S-V MMBD2004S	Vishay Diodes Inc.					



P500-G Solution: 5000 V Lightning 2/10 µsec, 500 A

BOURNS®

Asia-Pacific: Tel: +886-2 2562-4117 • Fax: +886-2 2562-4116

EMEA: Tel: +36 88 520 390 • Fax: +36 88 520 211

The Americas: Tel: +1-951 781-5500 • Fax: +1-951 781-5700

www.bourns.com

REV. 04/15

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[&]quot;TBU" is a registered trademark of Bourns, Inc. in the United States and other countries.